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(12) **United States Design Patent**  
**Klixbull et al.**

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(54) **PRINTED CIRCUIT BOARD**

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(\*\*) Term: **15 Years**

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(51) **LOC (12) Cl.** ..... **13-03**

(52) **U.S. Cl.**  
USPC ..... **D13/182**

(58) **Field of Classification Search**

USPC ..... D13/182; 361/748, 752, 760, 761, 807, 361/749, 764, 736, 720, 722, 750, 762, 361/763, 751; 174/250, 253, 255, 68.1, 174/256, 257; 363/144, 147; 700/22; 318/567, 568.1

CPC ..... H05K 3/284; H05K 3/30; H05K 3/301; H05K 3/303; H05K 1/18; H05K 1/181; H05K 1/182; H05K 1/183; H05K 1/00; H05K 1/02; H05K 1/0213; H05K 1/0284; H05K 1/0286; H05K 1/0287; H05K 1/11; H05K 1/189; H05K 7/1417; H05K 7/02; H05K 7/12; H05K 7/06; H05K 7/00; H05K 2201/05; H05K 2201/057; H05K 2201/09018; H01L 2924/14

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a printed circuit board, as shown and described.

**DESCRIPTION**

FIG. 1 is a front view of a first embodiment of a printed circuit board showing our new design;

FIG. 2 is a perspective view of the printed circuit board shown in FIG. 1;

FIG. 3 is a side view of the printed circuit board shown in FIG. 1;

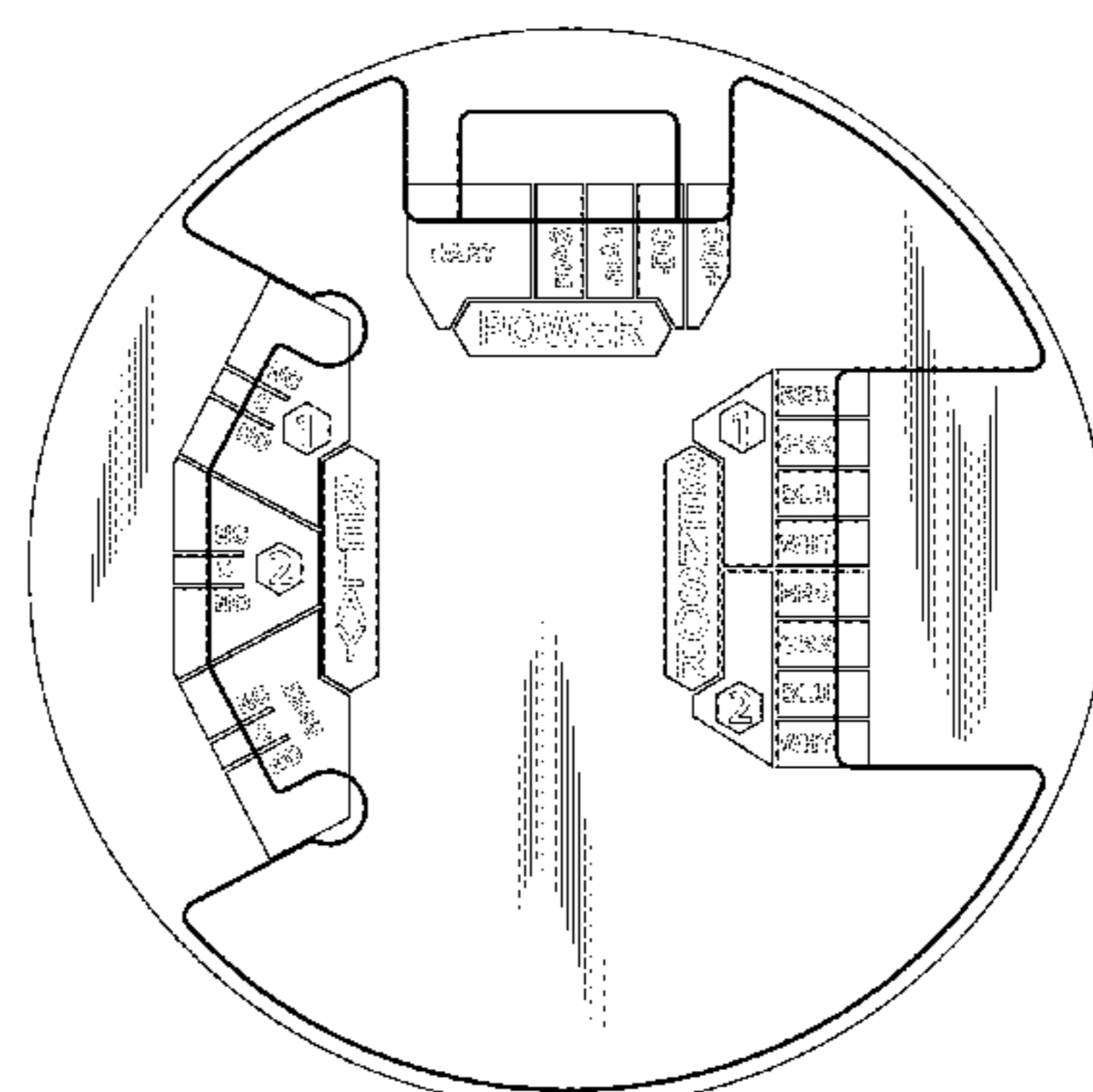
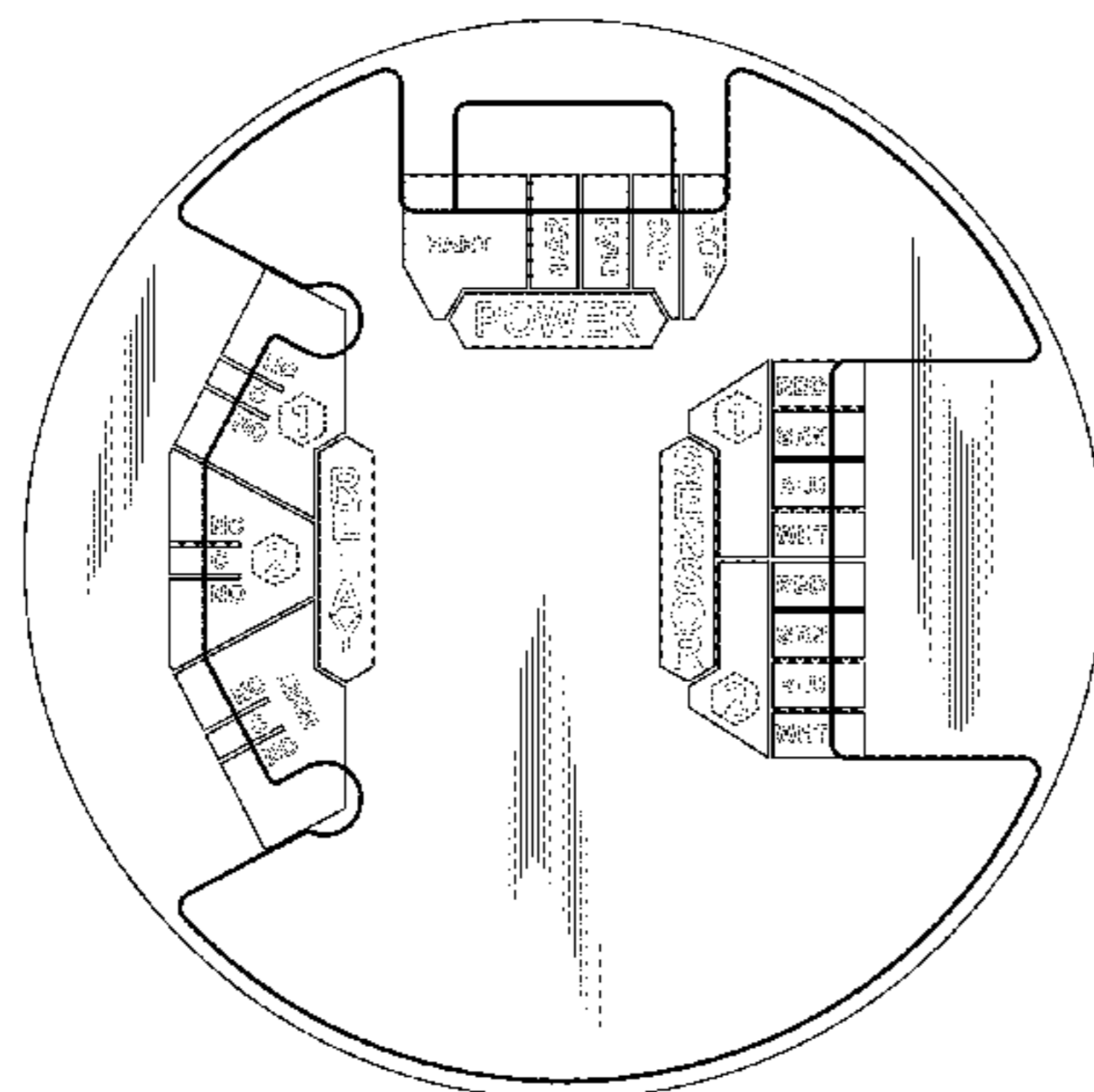
FIG. 4 is a front view of a second embodiment of a printed circuit board showing our new design;

FIG. 5 is a perspective view of the printed circuit board shown in FIG. 4; and,

FIG. 6 is a side view of the printed circuit board shown in FIG. 4.

The broken lines shown in FIGS. 1-6 represent environmental structure and form no part of the claimed design.

**1 Claim, 4 Drawing Sheets**



(56)

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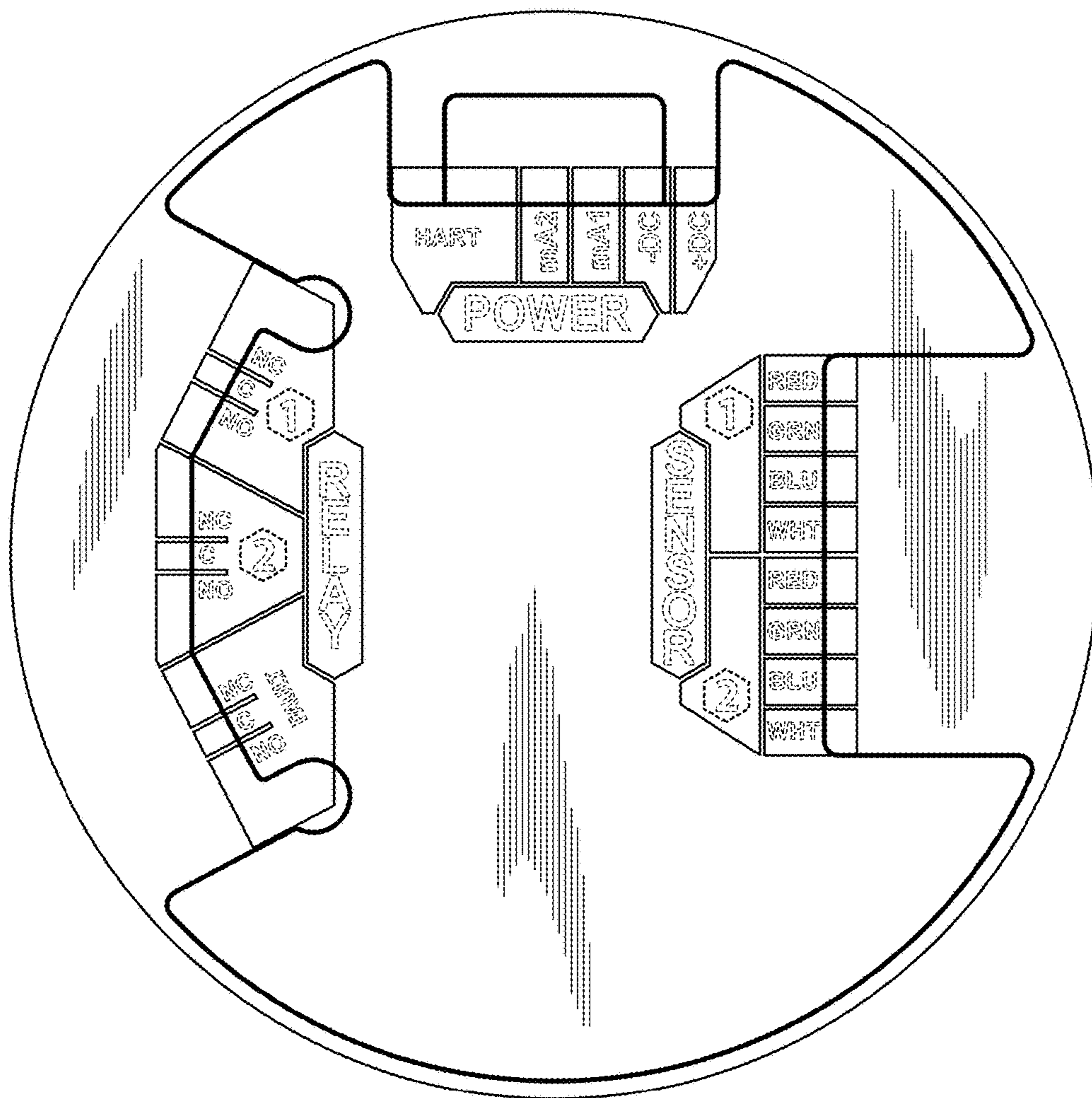


FIG. 1

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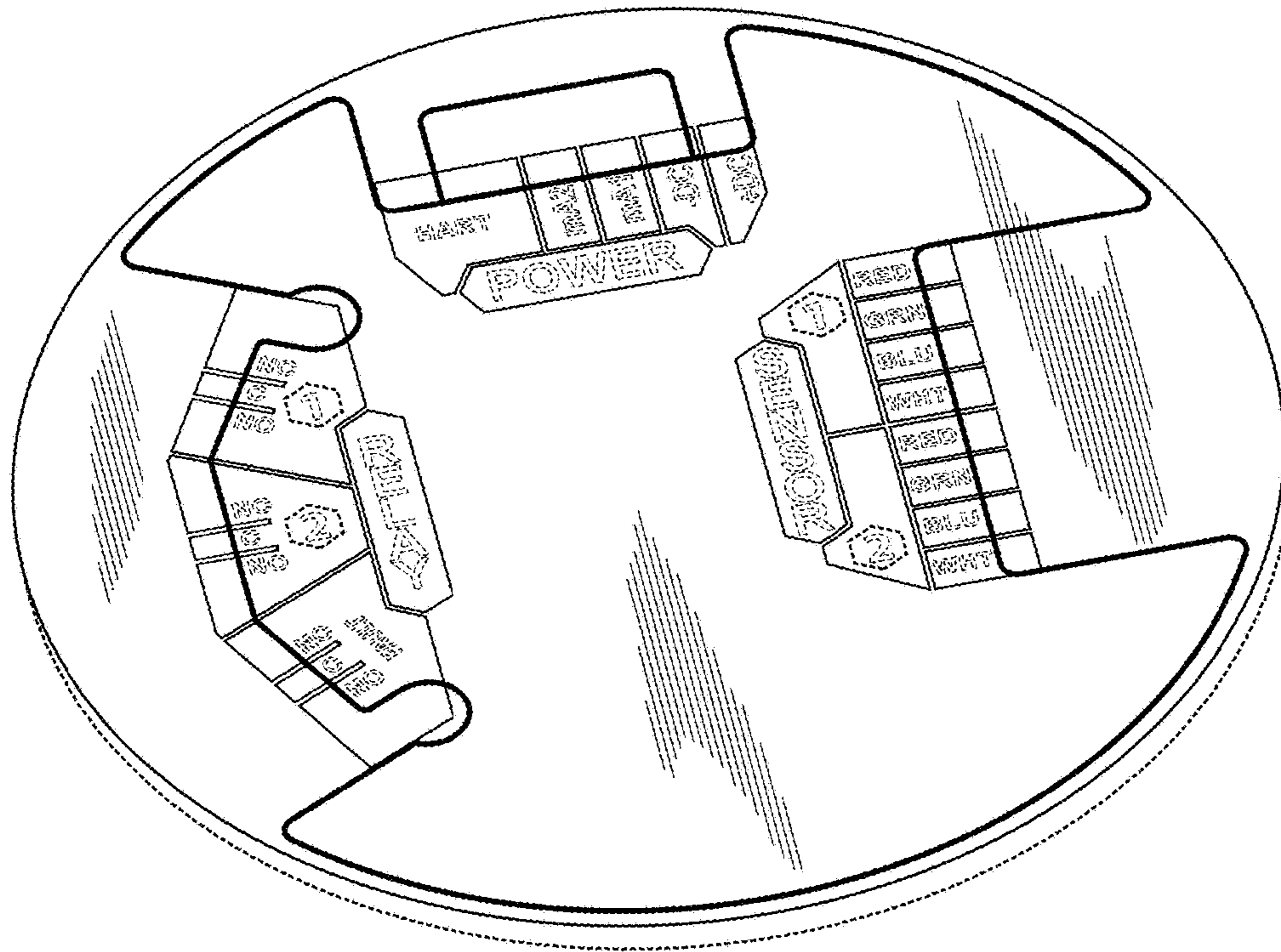


FIG. 2



FIG. 3

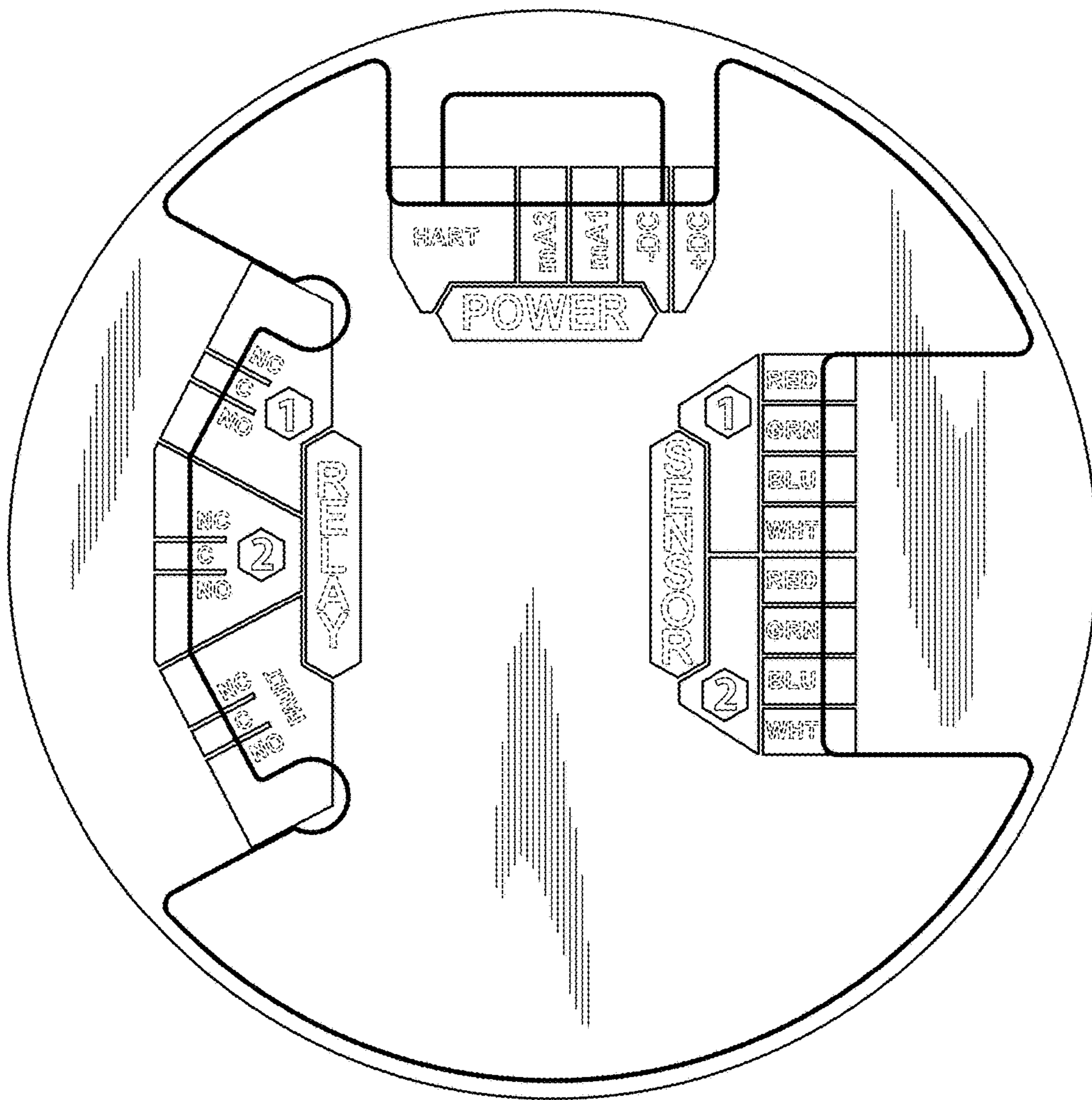


FIG. 4

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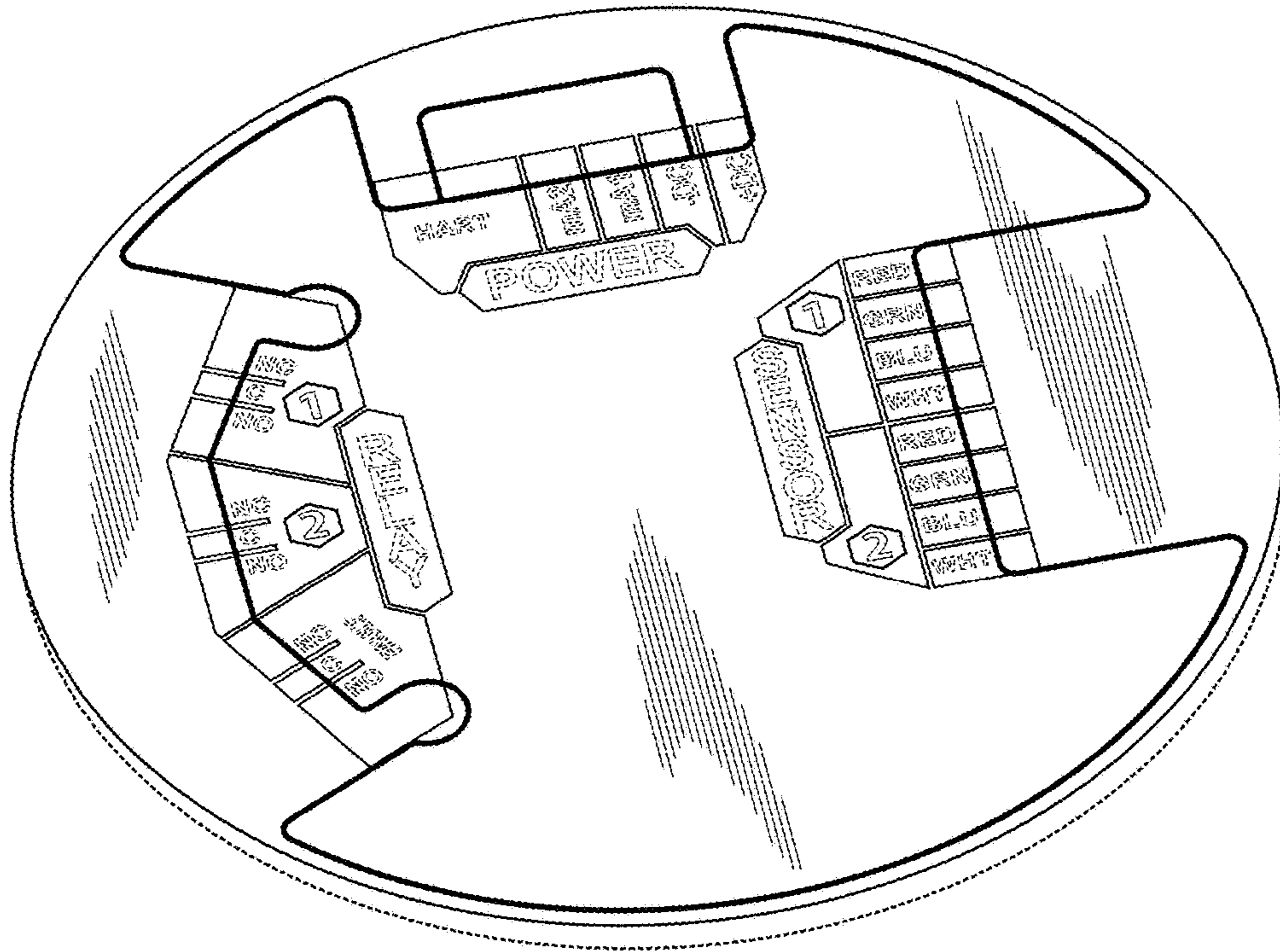


FIG. 5

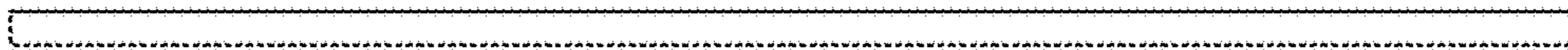


FIG. 6